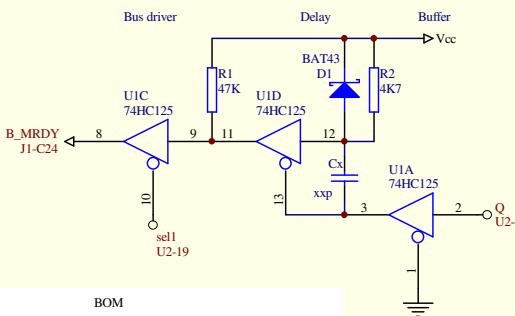
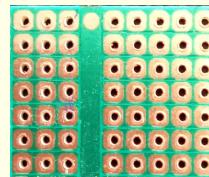


1 2 3 4 5 6

Timing:  
 5MHz bus FDC(2.5MHz) E=300nsec /E=100nsec  
 4MHz bus FDC(2MHz) E=375nsec /E=125nsec



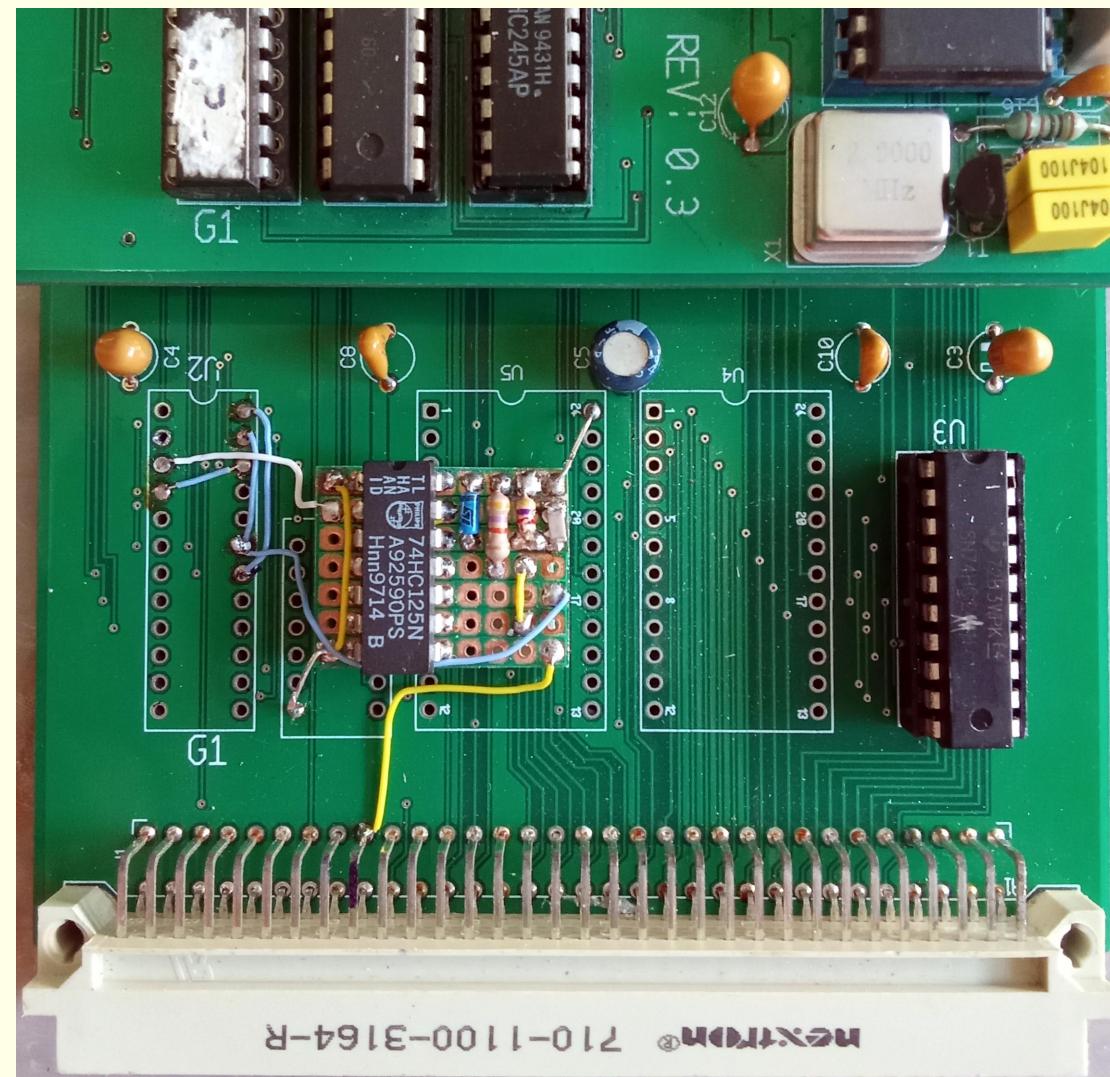
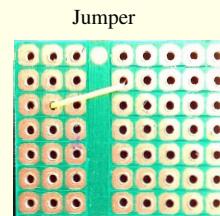
Print



BOM

#	Device	Value	Package type	Refdes
RES.250W	47K 10%	RES12	R1	
RES.125W	4K7 5%	RES12	R2	
CER CAP	39p 5%	1206 SMD	Cx	5MHz bus
CER CAP	56p 5%	1206 SMD	Cx	4MHz bus
DIODE.SCHOTT	BAT43	DIO_DO35	D1	
74HC125	74HC125	DIP14	U1	

Solder all parts like SMD.



NECXTREN 710-1100-3164-R

Title		
Size	Number	Revision
B		
Date: 15-Dec-2025	Sheet of	
File: C:\ISO\FLP_MRDY\FLP_MRDY.ddb	Drawn By:	

1 2 3 4 5 6